LCD / LCM SPECIFICATION



WINSTAR Display Co.,Ltd. 華凌光電股份有限公司

Winstar Display Co., LTD 華凌光電股份有限公司



WEB: https://www.winstar.com.tw E-mail: sales@winstar.com.tw

SPECIFICATION

CUSTOMER:	
MODULE NO.:	WG12864B-TFH-V#N

A.	PP	RC	VED	BY:
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(FOR CUSTOMER USE ONLY)

PCB VERSION:

DATA:

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY
45			

VERSION	DATE	REVISED	\$ SUMMARY	
		PAGE NO.		
M	2019/12/17		Precautions CD Modules	in



MODLE NO:

華凌光電股份有限公司

RECORDS OF REVISION

DOC. FIRST ISSUE

		т	
VERSION	DATE	REVISED PAGE NO.	SUMMARY
0	2007/03/07		First issue
A	2008/05/21		Modify backlight
			information
В	2008/09/10		Modify backlight
			information
C	2009/06/03		Modify backlight
		40	information
D	2009/06/18		Modify Timing
			Characteristics
Е	2010/02/27		Modify View area, Active
			area
F	2012/08/23		Modify Precautions in use
			of LCD Modules.
G	2013/03/08		Correct contour drawing
			Remove IC information
Н	2013/08/21		Modify Luminance
I	2016/01/27		Modify Precautions in use
			of LCD Modules
			& Static electricity test
J	2016/04/15		Modify Response Time

K	2017/04/11	Modify Backlight
		Information
		Modify IDD
L	2019/08/27	Modify Material List of
		Components for RoHs
M	2019/12/17	Modify Precautions in use
		of LCD Modules

Contents

- 1.Module Classification Information
- 2.Precautions in use of LCD Modules
- 3. General Specification
- 4. Absolute Maximum Ratings
- 5. Electrical Characteristics
- 6. Optical Characteristics
- 7.Interface Pin Function
- 8. Contour Drawing & Block Diagram
- 9.Reliability
- 10.Backlight Information
- 11.Inspection specification
- 12. Material List of Components for RoHs
- 13.Recommendable Storage

1. Module Classification Information

① Brand: WINSTAR DISPLAY CORPORATION

② Display Type: H→Character Type, G→Graphic Type, X→TAB Type, O→COG Type

③ Display Font: 128 * 64 dot

Model serials no.

 \bigcirc Backlight Type: N \rightarrow Without backlight T \rightarrow LED, White L \rightarrow LED, Full color

 $B\rightarrow EL$, Blue green $A\rightarrow LED$, Amber $J\rightarrow DIP$ LED, Blue $D\rightarrow EL$, Green $R\rightarrow LED$, Red $K\rightarrow DIP$ LED, White

W→EL, White O→LED, Orange E→DIP LED, Yellow Green

 $M\rightarrow EL$, Yellow Green $G\rightarrow LED$, Green $H\rightarrow DIP$ LED, Amber $F\rightarrow CCFL$, White $P\rightarrow LED$, Blue $I\rightarrow DIP$ LED, Red

 $Y\rightarrow$ LED, Yellow Green $X\rightarrow$ LED, Dual color $G\rightarrow$ LED, Green $C\rightarrow$ LED, Full color

© LCD Mode : B→TN Positive, Gray V→FSTN Negative, Blue

N→TN Negative, T→FSTN Negative, Black

L→VA Negative D→FSTN Negative (Double film)

 $H \rightarrow HTN$ Positive, Gray $F \rightarrow FSTN$ Positive $I \rightarrow HTN$ Negative, Black $K \rightarrow FSC$ Negative $U \rightarrow HTN$ Negative, Blue $S \rightarrow FSC$ Positive

M→STN Negative, Blue E→ISTN Negative, Black
G→STN Positive, Gray C→CSTN Negative, Black
Y→STN Positive, Yellow Green A→ASTN Negative, Black

② LCD Polarize A→Reflective, N.T, 6:00 H→Transflective, W.T,6:00

Type/ Temperature D→Reflective, N.T, 12:00 K→Transflective, W.T,12:00 range/ View G→Reflective, W. T, 6:00 C→Transmissive, N.T,6:00

direction J→Reflective, W. T, 12:00 F→Transmissive, N.T,12:00

B→Transflective, N.T,6:00 I→Transmissive, W. T, 6:00

E→Transflective, N.T.12:00 L→Transmissive, W.T,12:00

Special Code
V : Build in Negative voltage

N:IC NT7107, NT7108

#:Fit in with the ROHS Directions and regulations

2.Precautions in use of LCD Modules

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8) Winstar have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9) Winstar have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Winstar have the right to modify the version.)
- (10) To ensure the stability of the display screen, please apply screen saver after showing 30 mins of fixed display content.
- (11)Please heat up a little the tape sticking on the components when removing it; otherwise the components might be damaged.

3.General Specification

Item	Dimension	Unit
Number of dots	128 x 64	_
Module dimension	75.0 x 52.7 x 8.9 (MAX)	mm
View area	58.8 x 31.4	mm
Active area	55.01 x 27.49	mm
Dot size	0.40 x 0.40	mm
Dot pitch	0.43 x 0.43	mm
LCD type	FSTN Positive, Transflective (In LCD production, It will occur slightly color of can only guarantee the same color in the same be	
Duty	1/64	
View direction	6 o'clock	
Backlight Type	LED, White	
IC	NT7107, NT7108	

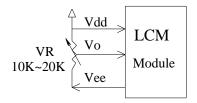
4.Absolute Maximum Ratings

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	T_{OP}	-20	_	+70	$^{\circ}$
Storage Temperature	T_{ST}	-30	_	+80	$^{\circ}\!\mathbb{C}$
Supply Voltage For Logic	V_{DD} - V_{SS}	-0.3	_	7.0	V
Driver Supply Voltage	V_{LCD}	V _{EE} -0.3	_	V _{DD} +0.3	V

5.Electrical Characteristics

ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
Supply Voltage For Logic	V_{DD} - V_{SS}	_	4.5	5.0	5.5	V
Supply Voltage For		Ta=-20°C	_	_	9.6	V
LCD	V_{DD} - V_{O}	Ta=25°℃	7.8	8.0	8.2	V
*Note		Ta=70°C	7.6	_	_	V
Input High Volt.	V_{IH}	_	$0.7~\mathrm{V_{DD}}$	_	$V_{ m DD}$	V
Input Low Volt.	V_{IL}	_	0		0.8	V
Output High Volt.	V_{OH}	_	2.4		_	V
Output Low Volt.	V_{OL}	_	_	× –	0.4	V
Supply Current	I_{DD}	V _{DD} =5.0V	1.5	3.2	6.0	mA

^{*} Note: Please design the VOP adjustment circuit on customer's main board

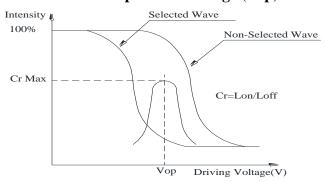


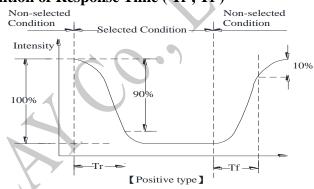
6.Optical Characteristics

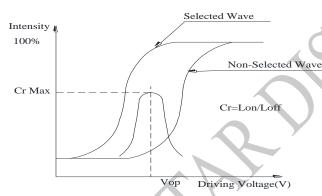
Item	Symbol	Condition	Min	Тур	Max	Unit
	θ	CR≧2	0	_	30	$\phi = 180^{\circ}$
Vious Amelo	θ	CR≧2	0	_	60	$\phi = 0^{\circ}$
View Angle	θ	CR≧2	0	_	45	$\phi = 90^{\circ}$
	θ	CR≧2	0	_	45	$\phi = 270^{\circ}$
Contrast Ratio	CR	_	_	5	_	_
Д.	T rise	_	_	200	300	ms
Response Time	T fall	_	_	250	350	ms

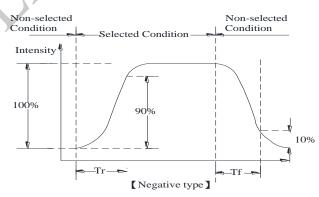
Definition of Operation Voltage (Vop)

Definition of Response Time (Tr, Tf)







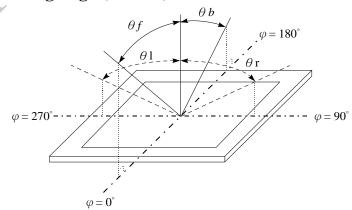


Conditions:

Operating Voltage: Vop Frame Frequency: 64 HZ Viewing Angle(θ , φ): 0° , 0°

Driving Waveform: 1/N duty, 1/a bias

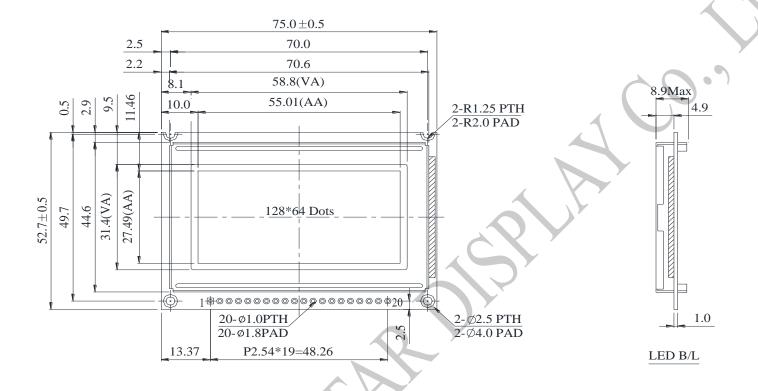
Definition of viewing angle($CR \ge 2$)



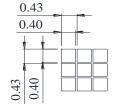
7.Interface Pin Function

Pin No.	Symbol	Level	Description
1	Vdd	5.0V	Supply voltage for logic
2	V_{SS}	0V	Ground
3	Vo	(Variable)	Contrast Adjustment
4	DB0	H/L	Data bus line
5	DB1	H/L	Data bus line
6	DB2	H/L	Data bus line
7	DB3	H/L	Data bus line
8	DB4	H/L	Data bus line
9	DB5	H/L	Data bus line
10	DB6	H/L	Data bus line
11	DB7	H/L	Data bus line
12	CS1	L	Select Column 1~ Column 64
13	CS2	L	Select Column 65~ Column 128
14	/RST	L	Reset signal
15	R/W	H/L	H: Read (MPU←Module) , L: Write (MPU→Module)
16	D/I	H/L	H: Data, L: Instruction
17	Е	H	Enable signal
18	Vee		Negative Voltage output
19	A	5-	Power Supply for LED backlight (+)
20	K	_	Power Supply for LED backlight (-)

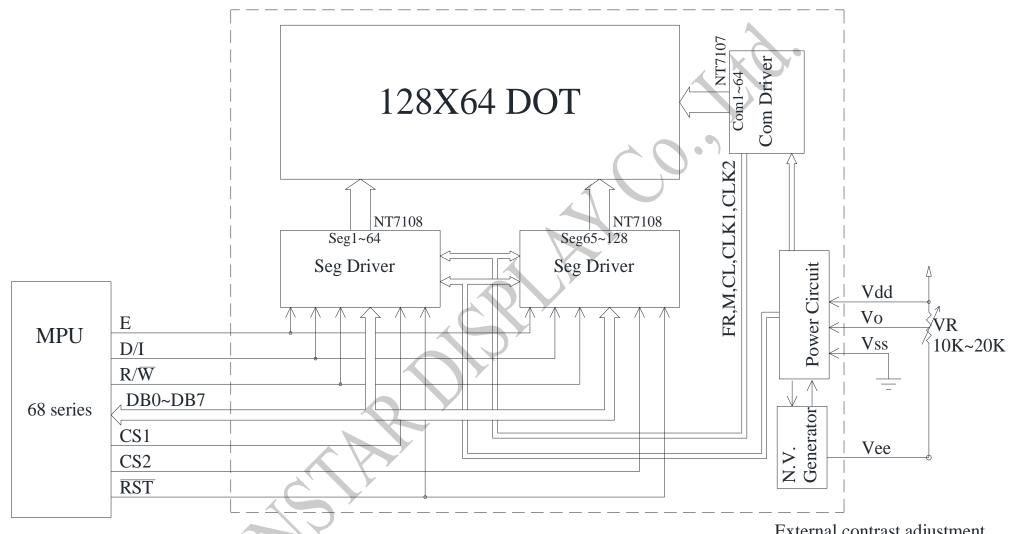
8.Contour Drawing & Block Diagram



PIN NO.	SYMBOL
1	Vdd
2	Vss
3	Vo
4	DB0
5	DB1
6	DB2
7	DB3
8	DB4
9	DB5
10	DB6
11	DB7
12	CS1
13	CS2
14	RST
15	R/\overline{W}
16	D/Ī
17	Е
18	Vee
19	A
20	K



The non-specified tolerance of dimension is ± 0.3 mm.



External contrast adjustment.

9.Reliability

Content of Reliability Test (Wide temperature, -20°C~70°C)

	Environmental Test		
Test Item	Content of Test	Test Condition	Not e
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1
High Temperature/ Humidity storage	The module should be allowed to stand at 60 °C,90% RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20°C 25°C 70°C 30min 5min 30min 1 cycle	-20°C/70°C 10 cycles	
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 1.5mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS= ± 600 V(contact), ± 800 v(air), RS= 330Ω CS= 150 pF 10 times	

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal

Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

10.Backlight Information

Specification

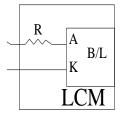
PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION
Supply Current	ILED	15	48	60	mA	V=3.5V(Note 1)
Supply Voltage	V	3.3	3.5	3.7	V	- x
Reverse Voltage	VR	_	_	5	V	-
Chromaticity	x	0.26	0.28	0.30	_	-
Coordinates	y	0.27	0.29	0.31	-(-0.
Luminance (Without LCD)	IV	520	650	_	cd/m²	ILED=48mA
LED Life Time						ILED=48mA
(For Reference	_	_	50K		Hr.	25°C,50-60%RH,
only)						(Note 2)
Color	White) 7			

Note: The LED of B/L is drive by current only, drive voltage is for reference only. drive voltage can make driving current under safety area (current between minimum and maximum).

Note 1: Supply current minimum value is only for reference since LED brightness efficiency keeps enhancing. Current consumption becomes less and less to achieve the same luminance.

Note 2:50K hours is only an estimate for reference.

.Drive from pin19,pin20



11.Inspection specification

NO	Item	Criterion				AQL
		Missing vertical	, horizonta	al segment, segme	nt contrast defect.	
		Missing characte	er, dot or	icon.		
		Display malfund	ction.			
01	Electrical	No function or r	o display.			0.65
01	Testing	Current consum	ption exce	eds product specif	fications.	0.65
		LCD viewing ar	ngle defect	- ·•	~ ~ ~	
		Mixed product t	ypes.			
		Contrast defect.				
	Black or	2.1 White and h	lack enote	on display < 0.25	mm, no more than	
02	white spots on	three white or bl			min, no more than	2.5
02	LCD (display		-	-	or lines within 2mm	2.3
	only)	2.2 Delisely space	ced. No ili	ore man two spots	s or lines within 3mm	
		3.1 Round type	: As follow	ving drawing		
		$\Phi = (x + y) / 2$		SIZE	Acceptable Q TY	
				Ф≦0.10	Accept no dense	
				$0.10 < \Phi \le 0.20$	2	
		4		$0.20 < \Phi \le 0.25$	1	2.5
				0.25 < Ф	0	2.3
	LCD black	X				
	spots, white	→ 1_1	<u>↓</u>			
03	spots, winte	• .	X Y			
03	contamination		Ī			
	(non-display)	3.2 Line type : (As follow:	ing drawing)		
	(non display)		Length	Width	Acceptable Q TY	
		_ /¥ w		W≤0.02	Accept no dense	
Á		→ + ++	L≦3.0	$0.02 < W \le 0.03$		2.5
		L	L≦2.5	$0.03 < W \le 0.05$	2	2.3
1				0.05 < W	As round type	

04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction.	Size Φ $Φ \le 0.20$ $0.20 < Φ \le 0.50$ $0.50 < Φ \le 1.00$ $1.00 < Φ$ Total Q TY	Acceptable Q TY Accept no dense 3 2 0 3	2.5
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NO	Item	Criterion			AQL
05	Scratches	Follow NO.3 LCD blace	ck spots, white spots, co	ntamination	
			=	ip thickness	
		L: Electrode pad length 6.1 General glass chip			
		z: Chip thickness	y: Chip width	x: Chip length	
06	Chipped	Z≦1/2t	Not over viewing area	x ≤ 1/8a	2.5
	glass		Not exceed 1/3k	$x \le 1/8a$	
		⊙ If there are 2 or more 6.1.2 Corner crack:	e chips, x is total length	of each chip.	
		z: Chip thickness	y: Chip width	x: Chip length	
4		$Z \le 1/2t$	Not over viewing area	$x \le 1/8a$	
		$1/2t < z \le 2t$	Not exceed 1/3k	x ≤ 1/8a	
		⊙ If there are 2 or more	e chips, x is the total len	gth of each chip.	

NO	Item	Criterion			AQL
		Symbols:			
		x: Chip length y: Ch	ip width z: Chip	thickness	
		k: Seal width t: Gla	ass thickness a: LCD	side length	
		L: Electrode pad length			
		6.2 Protrusion over termina	ıl :		
		6.2.1 Chip on electrode pad	1:		
06	Glass		≤ 1/8a	$z: Chip thickness \\ 0 < z \le t$ $\downarrow L$ $\downarrow Z$ X	2.5
		y: Chip width	x: Chip length	z: Chip thickness	
		$y \le L$	$x \le 1/8a$	$0 < z \leq t$	
		⊙ If the chipped area touch			
		remain and be inspected ac			
	_	⊙ If the product will be hear			
		be damaged.		···, ···· ···. ··· ··· ··· ··· ··· ··· ·	
4		6.2.3 Substrate protuberance	e and internal crack.		
		X.		v. langth	
			y: width $y \le 1/3L$	x : length $x \le a$	
	~		y = 1/3L →	$\Lambda \equiv \mathfrak{u}$	
		,			

NO	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
		8.1 Illumination source flickers when lit.	0.65
00	Backlight	8.2 Spots or scratched that appear when lit must be judged.	2.5
08	elements	Using LCD spot, lines and contamination standards.	
		8.3 Backlight doesn't light or color wrong.	0.65
		9.1 Bezel may not have rust, be deformed or have fingerprints,	2.5
09	Bezel	stains or other contamination.	
		9.2 Bezel must comply with job specifications.	0.65
		10.1 COB seal may not have pinholes larger than 0.2mm or contamination.	2.5
		10.2 COB seal surface may not have pinholes through to the IC.	2.5
		10.3 The height of the COB should not exceed the height	0.65
		indicated in the assembly diagram.	
		10.4 There may not be more than 2mm of sealant outside the	2.5
		seal area on the PCB. And there should be no more than three	
		places.	
		10.5 No oxidation or contamination PCB terminals.	2.5
10	PCB、COB	10.6 Parts on PCB must be the same as on the production	0.65
10	ТСВ СОВ	characteristic chart. There should be no wrong parts, missing	
		parts or excess parts.	
		10.7 The jumper on the PCB should conform to the product	0.65
		characteristic chart.	
		10.8 If solder gets on bezel tab pads, LED pad, zebra pad or	2.5
		screw hold pad, make sure it is smoothed down.	
		10.9 The Scraping testing standard for Copper Coating of PCB	2.5
	100	X 2	
		$X * Y \le 2mm^2$	
4		11.1 No un-melted solder paste may be present on the PCB.	2.5
		11.2 No cold solder joints, missing solder connections,	2.5
11	Soldering	oxidation or icicle.	
		11.3 No residue or solder balls on PCB.	2.5
		11.4 No short circuits in components on PCB.	0.65

NO	Item	Criterion	AQL
		12.1 No oxidation, contamination, curves or, bends on interface	2.5
		Pin (OLB) of TCP.	
		12.2 No cracks on interface pin (OLB) of TCP.	0.65
		12.3 No contamination, solder residue or solder balls on product.	2.5
		12.4 The IC on the TCP may not be damaged, circuits.	2.5
		12.5 The uppermost edge of the protective strip on the interface	2.5
		pin must be present or look as if it cause the interface pin to sever.	
	General	12.6 The residual rosin or tin oil of soldering (component or chip	2.5
12		component) is not burned into brown or black color.	
	appearance	12.7 Sealant on top of the ITO circuit has not hardened.	2.5
		12.8 Pin type must match type in specification sheet.	0.65
		12.9 LCD pin loose or missing pins.	0.65
		12.10 Product packaging must the same as specified on packaging	0.65
		specification sheet.	
		12.11 Product dimension and structure must conform to product	0.65
		specification sheet.	
		12.12 Visual defect outside of VA is not considered to be rejection.	0.65

12.Material List of Components for

RoHs

1. WINSTAR Display Co., Ltd hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	Cd	Pb	Hg	Cr6+	PBB	PBDE	DEHP	BBP	DBP	DIBP
Limited	100	1000	1000	1000	1000	1000	1000	1000	1000	1000
Value	ppm	ppm	ppm	ppm	ppm	ppm	ppm	ppm	ppm	ppm
Above limi	ted va	lue is s	set up a	accordi	ing to F	RoHS.	A			

2.Process for RoHS requirement : (only for RoHS inspection)

(1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.

(2) Heat-resistance temp. :

Reflow: 250°C,30 seconds Max.;

Connector soldering wave or hand soldering : 320°C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. $: 235\pm5^{\circ}C$;

Recommended customer's soldering temp. of connector: 280°C, 3 seconds.

13. Recommendable Storage

- 1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.



winstar <u>LCM Samp</u> Todule Number :		Feedback Sheet Page: 1
1 · Panel Specification :		
1. Panel Type:	☐ Pass	□ NG ,
2. View Direction:	Pass	□ NG ,
3. Numbers of Dots:	☐ Pass	□ NG,
4. View Area:	Pass	□ NG ,
5. Active Area:	☐ Pass	□ NG,
6. Operating Temperature:	Pass	□ NG,
7. Storage Temperature :	Pass	□ NG,
8. Others:		
2 · Mechanical Specification :		
1. PCB Size:	Pass	□ NG,
2. Frame Size:	Pass	□ NG,
3. Materal of Frame:	Pass	□ NG,
4. Connector Position:	Pass	□ NG,
5. Fix Hole Position:	Pass	□ NG,
6. Backlight Position:	☐ Pass	□ NG,
7. Thickness of PCB:	☐ Pass	□ NG ,
8. Height of Frame to PCB:	☐ Pass	□ NG,
9. Height of Module:	Pass	□ NG ,
10. Others:	☐ Pass	□ NG ,
3 · Relative Hole Size:		
1. Pitch of Connector:	☐ Pass	□ NG ,
2. Hole size of Connector:	☐ Pass	□ NG ,
3. Mounting Hole size:	☐ Pass	□ NG ,
4. Mounting Hole Type:	☐ Pass	□ NG ,
5. Others:	☐ Pass	□ NG ,
4 · Backlight Specification :		
1. B/L Type:	Pass	☐ NG ,
2. B/L Color:	Pass	\square NG ,
3. B/L Driving Voltage (Referen	ence for LED	
4. B/L Driving Current:	☐ Pass	□ NG ,
5. Brightness of B/L:	Pass	□ NG ,
6. B/L Solder Method:	Pass	□ NG ,
7. Others:	☐ Pass	□ NG ,
	>> Go to	page 2 <<

	le Number:		Page: 2
5、	Electronic Characteristics of	Module:	
1.	Input Voltage:	Pass	☐ NG ,
2.	Supply Current:	Pass	☐ NG ,
3.	Driving Voltage for LCD:	Pass	□ NG ,
4.	Contrast for LCD:	☐ Pass	☐ NG ,
5.	B/L Driving Method:	Pass	□ NG ,
6.	Negative Voltage Output:	☐ Pass	□ NG ,
7.	Interface Function:	☐ Pass	□ NG ,
8.	LCD Uniformity:	☐ Pass	☐ NG ,
9.	ESD test:	Pass	□ NG,
10.	Others:	Pass	□ NG ,